# Low frequency amplifier

## 2SD2700

#### Application

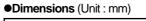
Low frequency amplifier Driver

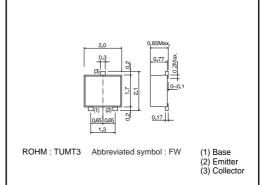
#### Features

1) A collector current is large.

2) VCE(sat)  $\leq$  180mV

at Ic = 1A/IB = 50mA





#### ●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit	
Collector-base voltage	Vсво	15	V	
Collector-emitter voltage	VCEO	12	V	
Emitter-base voltage	Vebo	6	V	
Collector current	lc	2	А	
Collector current	Іср	4	A*1	
Dewer discipation	Pc	0.4	W	
Power dissipation	ΤC	0.8*2		
Junction temperature	Tj	150	°C	
Range of storage temperature	Tstg	-55 to +150	°C	
*1 Single pulse Pw=1ms				

\*2 Mounted on a 25×25×<sup>t</sup>0.8mm Ceramic substrate

#### •Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-base breakdown voltage	ВУсво	15	-	-	V	Ic=10μA
Collector-emitter breakdown voltage	BVCEO	12	-	-	V	Ic=1mA
Emitter-base breakdown voltage	ВVево	6	-	-	V	Ιε=10μΑ
Collector cutoff current	Ісво	-	-	100	nA	Vcb=15V
Emitter cutoff current	Іево	-	-	100	nA	VEB=6V
Collector-emitter saturation voltage	VCE(sat)	-	90	180	mV	Ic=1A, IB=50mA
DC current gain	hfe	270	-	680	-	Vce=2V, Ic=200mA*
Transition frequency	f⊤	-	360	-	MHz	Vce=2V, Ie=-200mA, f=100MHz*
Corrector output capacitance	Cob	-	20	-	pF	Vcb=10V, Ie=0A, f=1MHz

\* Pulsed

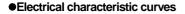
#### Packaging specifications

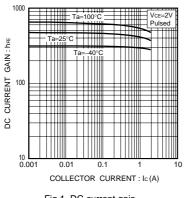
	Package	Taping
	Code	TL
Туре	Quantity (pcs)	3000
2SD2700		0

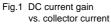


#### 2SD2700

#### Transistors







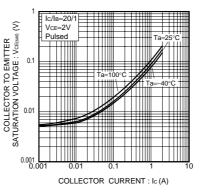
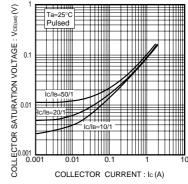
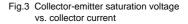


Fig.2 Base-emitter saturation voltage vs. collector current





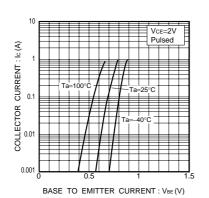


Fig.4 Grounded emitter propagation characteristics

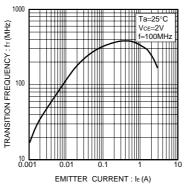
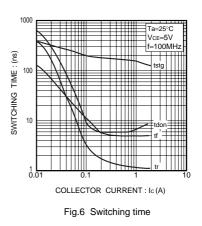
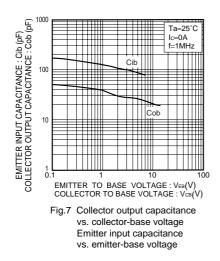


Fig.5 Gain bandwidth product vs. emitter current







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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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